Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

Features

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- This is a Pb–Free Device

Mechanical Characteristics

- Case: Epoxy, Molded
- Epoxy Meets UL 94 V-O @ 0.125 in
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Rating: Human Body Model (HBM) 3B Machine Model (MM) C

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	600	V
Average Rectified Forward Current	I _{F(AV)}	3.0 @ T _L = 105°C	А
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	100	A
Operating Junction Temperature	TJ	- 65 to +175	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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ULTRAFAST RECTIFIERS 3 AMPERES 600 VOLTS



SMB CASE 403A

MARKING DIAGRAM



B36B	= Specific Device Code
А	= Assembly Location
Υ	= Year
WW	= Work Week
•	= Pb-Free Package
(Note: N	Aicrodot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MURS360BT3G	SMB (Pb-Free)	2500/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

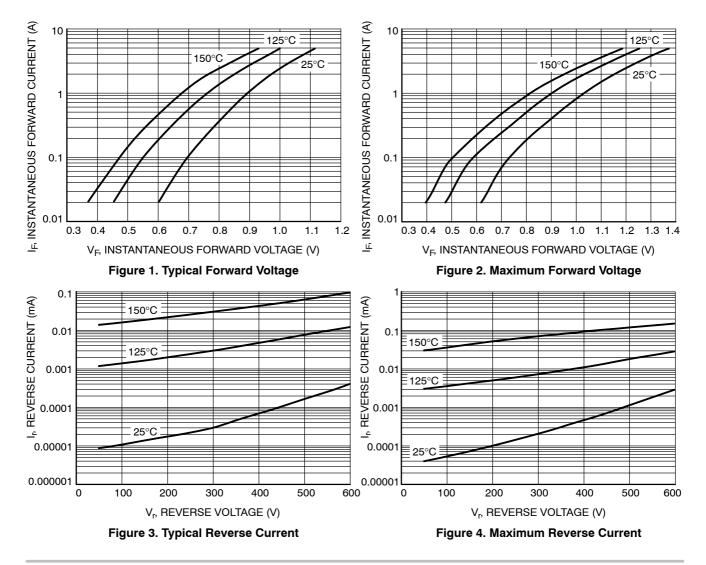
Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Lead (Note 1) Thermal Resistance, Junction-to-Ambient (Note 1)	${\sf R}_{ heta {\sf JL}} \ {\sf R}_{ heta {\sf JA}}$	14 125	°C/W

1. Mounted with minimum recommended pad size, PC Board FR4.

ELECTRICAL CHARACTERISTICS

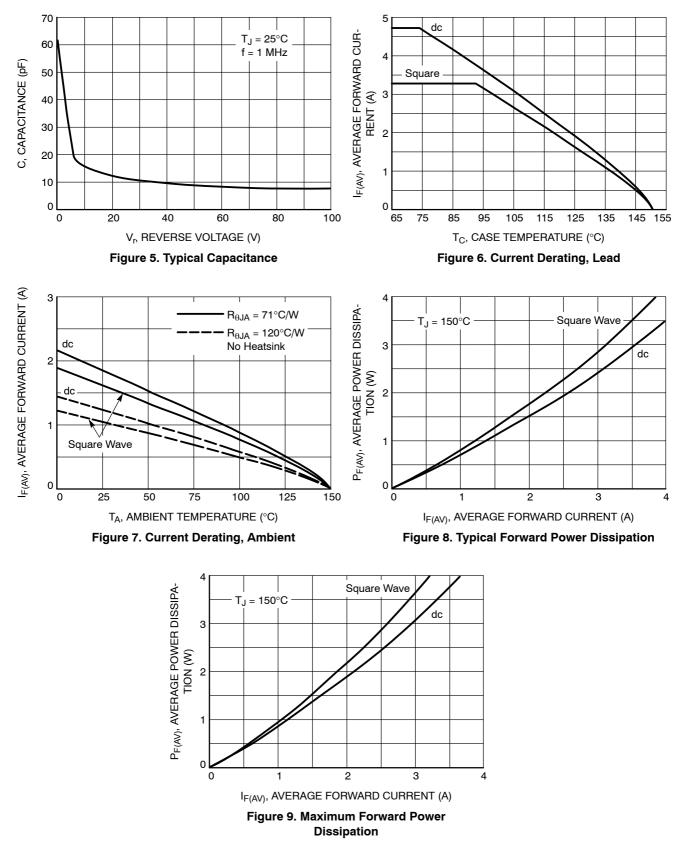
Characteristic	Symbol	Тур	Max	Unit
Maximum Instantaneous Forward Voltage (Note 2) (i _F = 3.0 A, T _J = 25°C) (i _F = 3.0 A, T _J = 150°C)	v _F	0.83	1.25 1.05	V
Maximum Instantaneous Reverse Current (Note 2) (Rated DC Voltage, $T_J = 25^{\circ}$ C) (Rated DC Voltage, $T_J = 150^{\circ}$ C)	İR	_ 95	3.0 150	μΑ
Maximum Reverse Recovery Time ($i_F = 1.0 \text{ A}$, di/dt = 50 A/µs) ($i_F = 0.5 \text{ A}$, $i_R = 1.0 \text{ A}$, I_R to 0.25 A)	t _{rr}		75 50	ns
Maximum Forward Recovery Time (i _F = 1.0 A, di/dt = 100 A/µs, Rec. to 1.0 V)	t _{fr}		50	ns

2. Pulse Test: Pulse Width = 300 $\mu s,$ Duty Cycle \leq 2.0%.



TYPICAL CHARACTERISTICS





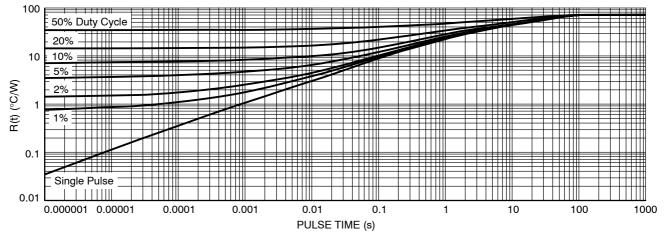
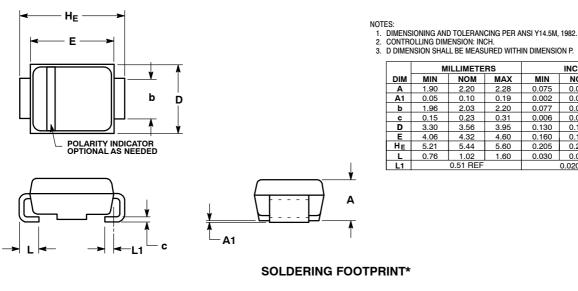


Figure 10. Thermal Response, Junction-to-Ambient

PACKAGE DIMENSIONS

SMB DO-214AA CASE 403A-03 **ISSUE H**



2.261 0.089 2.743 0.108 2.159 0.085 $\left(\frac{mm}{inches}\right)$ SCALE 8.1

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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